



STN888

HIGH VOLTAGE, HIGH PERFORMANCE, LOW VOLTAGE PNP TRANSISTOR

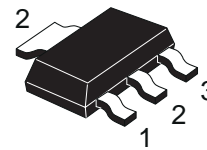
PRELIMINARY DATA

Type	Marking
STN888	N888

- VERY LOW COLLECTOR TO EMITTER SATURATION VOLTAGE
- D.C CURRENT GAIN, $h_{FE} > 100$
- 6 A CONTINUOUS COLLECTOR CURRENT
- SOT-223 PLASTIC PACKAGE FOR SURFACE MOUNTING CIRCUITS
- AVAILABLE IN TAPE AND REEL PACKING

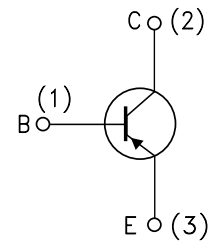
APPLICATIONS

- POWER MANAGEMENT IN PORTABLE EQUIPMENT
- VOLTAGE REGULATION IN BIAS SUPPLY CIRCUITS
- SWITCHING REGULATOR IN BATTERY CHARGER APPLICATIONS
- HEAVY LOAD DRIVER



SOT-223

INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage ($I_E = 0$)	-60	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	-30	V
V_{EBO}	Emitter-Base Voltage ($I_C = 0$)	-6	V
I_C	Collector Current	-6	A
I_{CM}	Collector Peak Current	-12	A
P_{tot}	Total Dissipation at $T_C = 25\text{ }^\circ\text{C}$	3	W
T_{stg}	Storage Temperature	-65 to 150	$^\circ\text{C}$
T_j	Max. Operating Junction Temperature	150	$^\circ\text{C}$

STN888

THERMAL DATA

$R_{thj-amb}$ •	Thermal Resistance Junction-Ambient	Max	41.6	°C/W
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• Device mounted on a PCB area of 1 cm²

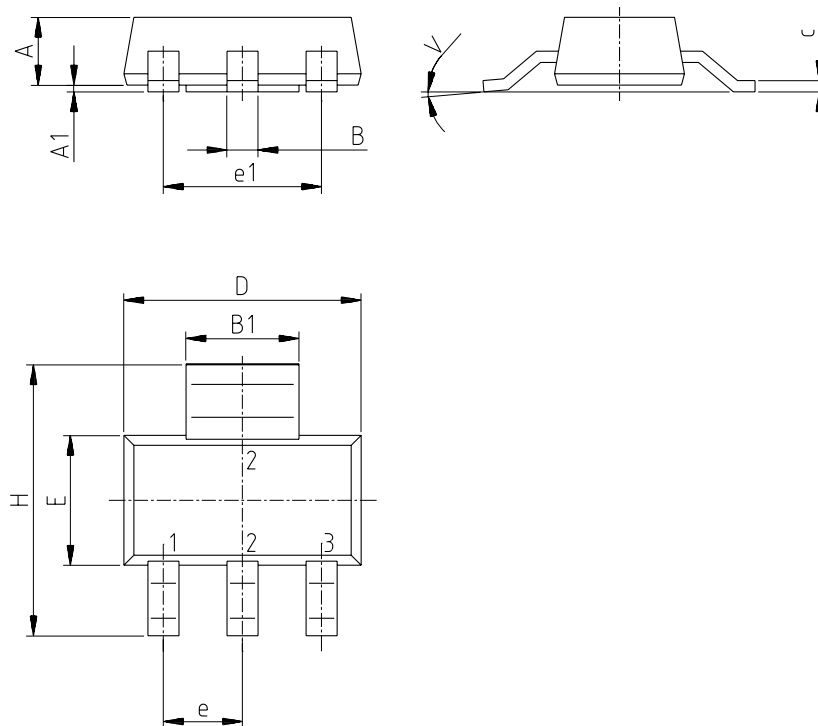
ELECTRICAL CHARACTERISTICS (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CBO}	Collector Cut-off Current (I _E = 0)	V _{CB} = -30 V V _{CB} = -30 V T _C = 100 °C			-10 -1	nA μA
I_{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = -6 V			-10	nA
V _{(BR)CEO} *	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = -10 mA	-30			V
V _{(BR)CBO}	Collector-Base Breakdown Voltage (I _E = 0)	I _C = -100 μA	-60			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	I _E = -100 μA	-6			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = -500 mA I _B = -5 mA I _C = -2 A I _B = -50 mA I _C = -6 A I _B = -250 mA I _C = -8 A I _B = -400 mA I _C = -10 A I _B = -500 mA			-0.13 -0.17 -0.45 1 1.5	V V V V V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = -2 mA I _B = -50 mA I _C = -6 mA I _B = -250 mA			-1.0 -1.2	V V
h _{FE} *	DC Current Gain	I _C = -10 mA V _{CE} = -1 V I _C = -500 mA V _{CE} = -1 V I _C = -5 A V _{CE} = -1 V I _C = -5 A V _{CE} = -1 V T _C = 100°C I _C = -8 A V _{CE} = -1 V I _C = -10 A V _{CE} = -1 V	150 150 75 75 40 15	200 200 100 100 55 25	300	
t _d t _r t _s t _f	Delay Time RiseTime StorageTime Fall Time	I _C = -3 A I _{B1} = - I _{B2} = -60 mA V _{CC} = -20 V		60 170 75 180	100 220 100 230	ns ns ns ns

* Pulsed: Pulse duration = 300 μs, duty cycle ≤ 1.5 %

SOT-223 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.80			0.071
B	0.60	0.70	0.80	0.024	0.027	0.031
B1	2.90	3.00	3.10	0.114	0.118	0.122
c	0.24	0.26	0.32	0.009	0.010	0.013
D	6.30	6.50	6.70	0.248	0.256	0.264
e		2.30			0.090	
e1		4.60			0.181	
E	3.30	3.50	3.70	0.130	0.138	0.146
H	6.70	7.00	7.30	0.264	0.276	0.287
V			10°			10°
A1		0.02				



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